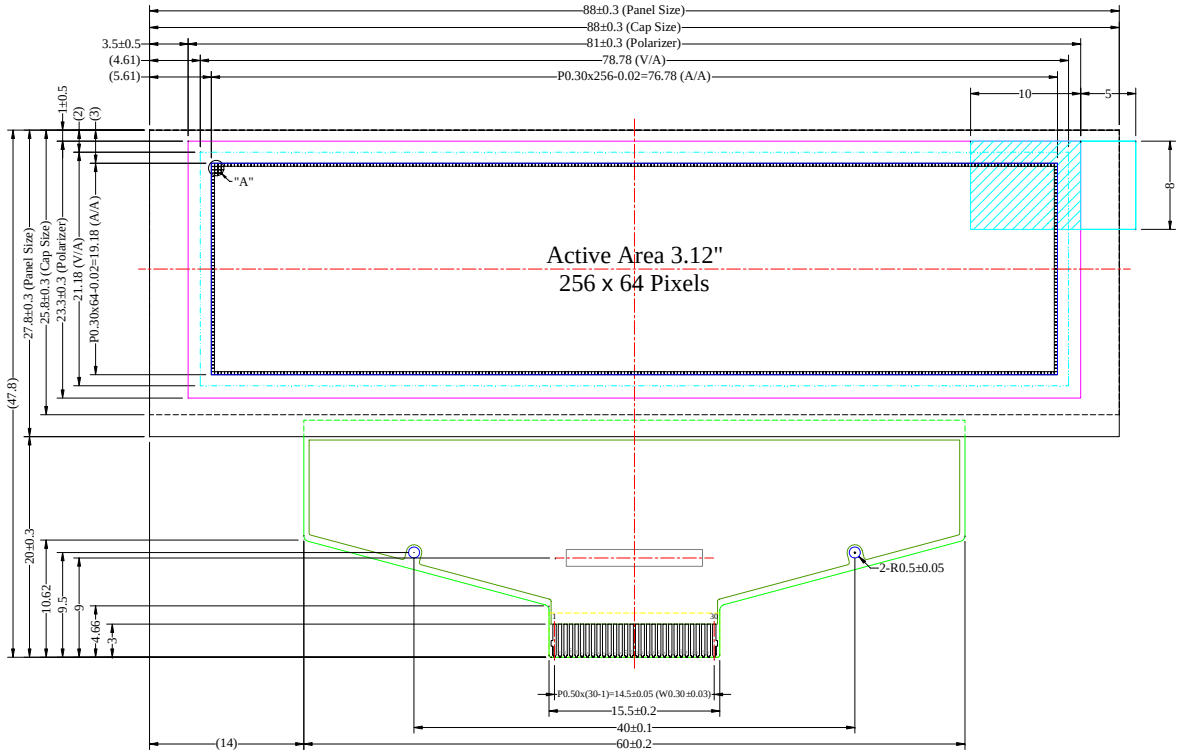
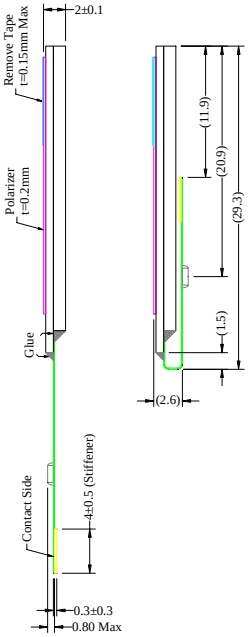
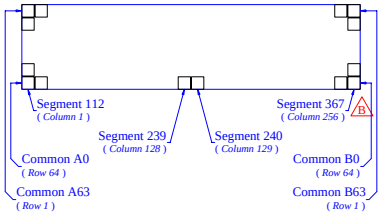
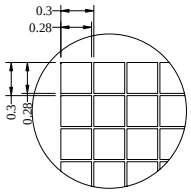
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Item	Date	Remark
A	20080825	Original Drawing
B	20091224	Modify Column256 define









Detail "A"
Scale (10:1)

Pin	Symbol
1	N.C. (GND)
2	VSS
3	VCC
4	VCOMH
5	VLSS
6	D7
7	D6
8	D5
9	D4
10	D3
11	D2
12	D1
13	D0
14	E/RD#
15	R/W#
16	BS0
17	BS1
18	DC#
19	CS#
20	RES#
21	FR
22	IREF
23	N.C.
24	VDDIO
25	VDD
26	VCI
27	VSL
28	VLSS
29	VCC
30	N.C. (GND)

Notes:

1. Color: White
2. Driver IC: SSD1322
3. Die Size: 12374um x 1526um
4. COF Number: SSD1322U
5. Interface:
   8-bit 68XX/80XX Parallel, 3-/4-wire SPI
6. General Tolerance: ±0.30
7. The total thickness (2.10 Max) is without polarizer protective film & remove tape.
   The actual assembled total thickness with above materials should be 2.35 Max.

Customer Approval Signature	WiseChip Semiconductor Inc.						Drawing Number	Rev.
							DMG5664CNCF21	B
	Unless Otherwise Specified		Title	UG-5664ASWEF01 Folding Type OEL Display Module Pixel Number: 256 x 64, Monochrome, COF Package			Material	
	Unit	mm					Soda Lime / Polyimide	
	General Roughness							
	Tolerance			Drawn	E.E.	Panel / E.	P.M.	
	Dimension	±0.30	By	Gary Lin	Ting-Kuo Hu	Ivy Lo	Tiffany Hsu	Scale / Sheet / Size
	Angle	±1	Date	20091224	20091224	20091224	20091224	1:1 / 1 of 1 / A3